



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification Number:	20260901004.0	Notification Issued	September 01, 2026
Datasheet for TUSB73x0			

Change Type(s)	Data Sheet/Electrical Specification
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Notification Details

Description of Change:		
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.		
		TUSB7320, TUSB7340 SLLSE76R – MARCH 2011 – REVISED AUGUST 2026
Changes from Revision Q (March 2024) to Revision R (August 2026)		Page
• Removed support of 24MHz clocking.....		31
The datasheet number will be changing.		
Device Family	Change From:	Change To:
TUSB73x0	SLLSE76Q	SLLSE76R
These changes may be reviewed at the datasheet links provided.		
http://www.ti.com/product/TUSB7320		
Reason for Change:	To accurately reflect device characteristics	
Anticipated impact on Form, Fit, Function, Quality or Reliability:	None	
Changes to product identification resulting from this PCN:	None	

Products Affected:			
TUSB7340IRKMR	TUSB7340IRKMR.A	TUSB7340IRKMT	TUSB7340IRKMT.A
TUSB7340IRKMTG4	TUSB7340IRKMTG4.A	TUSB7340RKMR	TUSB7340RKMR.A
TUSB7340RKMT	TUSB7340RKMT.A		

In performing change qualifications, Texas Instruments follows integrated circuit industry standards in performing defect mechanism analysis and failure mechanism-based accelerated environmental testing to ensure wafer fab process, assembly process and product quality and reliability. As encouraged by these standards, TI uses both product-specific and generic (family) data in qualifying its changes. For devices to be categorized as a 'product qualification family' for generic data purposes, they must share similar product, wafer fab process and

assembly process elements. The applicability of generic data (also known at TI as Qualification by Similarity (QBS)) is determined by the Reliability Engineering function following these industry standards. Generic data is shown in the qualification report in columns titled "QBS Process" (for wafer fab process), "QBS Package" (for assembly process) and "QBS Product" (for product family).

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

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